

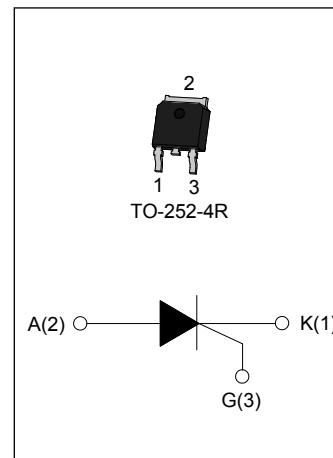


JCT610/810 Series 10A SCRs

Rev.7.0

DESCRIPTION:

With high ability to withstand the shock loading of large current, JCT610/810 series of silicon controlled rectifiers provide high dv/dt rate with strong resistance to electromagnetic interference. They are especially recommended for use on solid state relay, motorcycle, power charger, T-tools etc. Package TO-252-4R is RoHS compliant. (2011/65/EU)

**MAIN FEATURES**

| Symbol | JCT610 | JCT810 |
|-------------------|--------|--------------------|
| V_{DRM}/V_{RRM} | 600V | 800V |
| $I_{T(RMS)}$ | 10A | |
| I_{GT} | | $\leq 10\text{mA}$ |

ABSOLUTE MAXIMUM RATINGS

| Parameter | Symbol | Value | Unit |
|--|--------------|---------|------------------------|
| Storage junction temperature range | T_{stg} | -40-150 | °C |
| Operating junction temperature range | T_j | -40-150 | °C |
| Repetitive peak off-state voltage($T_j=25^\circ\text{C}$) | V_{DRM} | 600/800 | V |
| Repetitive peak reverse voltage($T_j=25^\circ\text{C}$) | V_{RRM} | 600/800 | V |
| RMS on-state current <small>($T_c=105^\circ\text{C}$)</small> | $I_{T(RMS)}$ | 10 | A |
| Non repetitive surge peak on-state current <small>($t_p=10\text{ms}$)</small> | I_{TSM} | 120 | A |
| I^2t value for fusing ($t_p=10\text{ms}$) | I^2t | 72 | A^2s |
| Critical rate of rise of on-state current <small>($I_G=2 \times I_{GT}$)</small> | dI/dt | 50 | $\text{A}/\mu\text{s}$ |
| Peak gate current | I_{GM} | 4 | A |
| Average gate power dissipation | $P_{G(AV)}$ | 1 | W |
| Peak gate power | P_{GM} | 5 | W |

ELECTRICAL CHARACTERISTICS ($T_j=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Test Condition | Value | | | Unit |
|----------|---|-------|------|------|------------|
| | | MIN. | TYP. | MAX. | |
| I_{GT} | $V_D=12\text{V}$ $R_L=33\Omega$ | - | - | 10 | mA |
| V_{GT} | | - | - | 1.5 | V |
| V_{GD} | $V_D=V_{DRM}$ $T_j=150^\circ\text{C}$ $R_L=3.3\text{k}\Omega$ | 0.2 | - | - | V |
| I_L | $I_G=1.2I_{GT}$ | - | - | 40 | mA |
| I_H | $I_T=500\text{mA}$ | - | - | 30 | mA |
| dV/dt | $V_D=2/3V_{DRM}$ Gate Open $T_j=150^\circ\text{C}$ | 200 | - | - | V/ μ s |

STATIC CHARACTERISTICS

| Symbol | Parameter | Value(MAX) | Unit |
|-----------|--|------------|---------------|
| V_{TM} | $I_{TM}=20\text{A}$ $t_p=380\mu\text{s}$ | 1.55 | V |
| I_{DRM} | $V_D=V_{DRM}$ $V_R=V_{RRM}$ | 5 | μA |
| I_{RRM} | | 1 | mA |

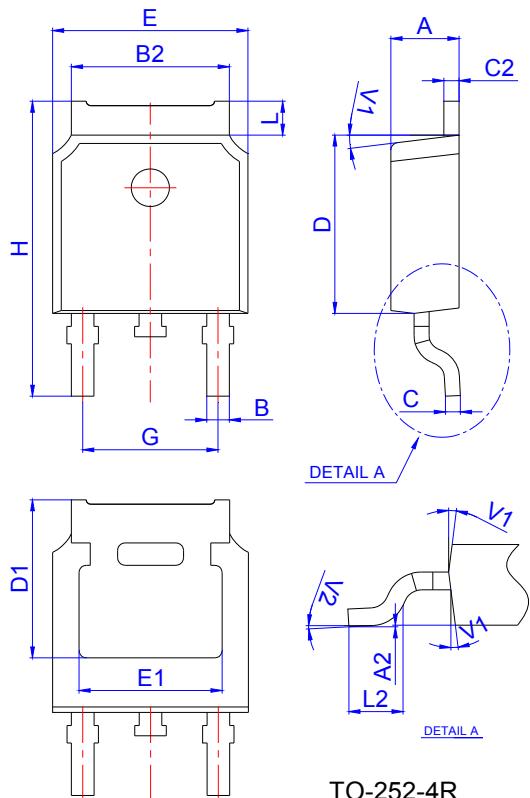
THERMAL RESISTANCES

| Symbol | Parameter | Value | Unit |
|---------------|-----------------------------------|-------|---------------------------|
| $R_{th(j-c)}$ | junction to case(AC) TO-252-4R | 2.0 | $^\circ\text{C}/\text{W}$ |
| $R_{th(j-a)}$ | | 70 | |

ORDERING INFORMATION

| | | | | |
|--|------|---------------------------------------|----|--|
| J | CT | 6 | 10 | K |
| <u>JieJie Microelectronics Co.,Ltd</u> | | | | K: TO-252-4R KTR:TO-252-4R(Tape&Reel) |
| | SCRs | | | |
| | | 6: $V_{DRM}/V_{RRM} \geq 600\text{V}$ | | $I_{T(\text{RMS})}:10\text{A}$ |
| | | 8: $V_{DRM}/V_{RRM} \geq 800\text{V}$ | | |

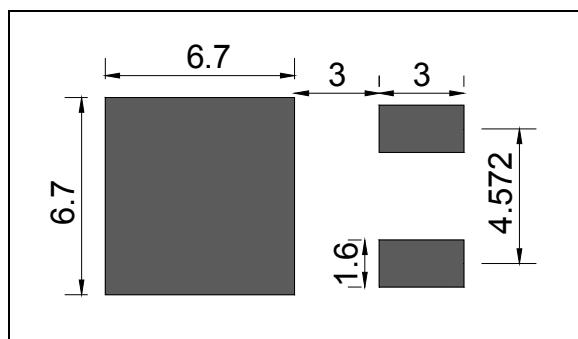
PACKAGE MECHANICAL DATA



TO-252-4R

| Ref. | Dimensions | | | | | |
|------|-------------|------|-------|----------|------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 2.10 | | 2.50 | 0.083 | | 0.098 |
| A2 | 0 | | 0.10 | 0 | | 0.004 |
| B | 0.66 | | 0.86 | 0.026 | | 0.034 |
| B2 | 5.18 | | 5.48 | 0.202 | | 0.216 |
| C | 0.40 | | 0.60 | 0.016 | | 0.024 |
| C2 | 0.44 | | 0.58 | 0.017 | | 0.023 |
| D | 5.90 | | 6.30 | 0.232 | | 0.248 |
| D1 | 5.30REF | | | 0.209REF | | |
| E | 6.40 | | 6.80 | 0.252 | | 0.268 |
| E1 | 4.63 | | | 0.182 | | |
| G | 4.47 | | 4.67 | 0.176 | | 0.184 |
| H | 9.50 | | 10.70 | 0.374 | | 0.421 |
| L | 1.09 | | 1.21 | 0.043 | | 0.048 |
| L2 | 1.35 | | 1.65 | 0.053 | | 0.065 |
| V1 | | 7° | | | 7° | |
| V2 | 0° | | 6° | 0° | | 6° |

FOOTPRINT-TO-252-4R (dimensions in mm)



MARKING

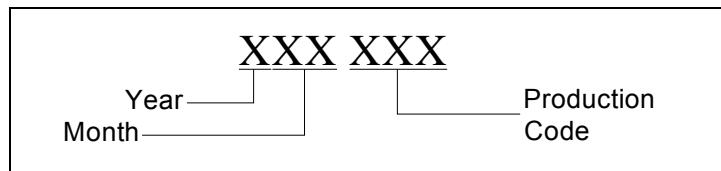
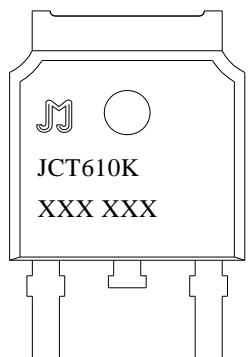


FIG.1 Maximum power dissipation versus RMS on-state current



FIG.3: Surge peak on-state current versus number of cycles

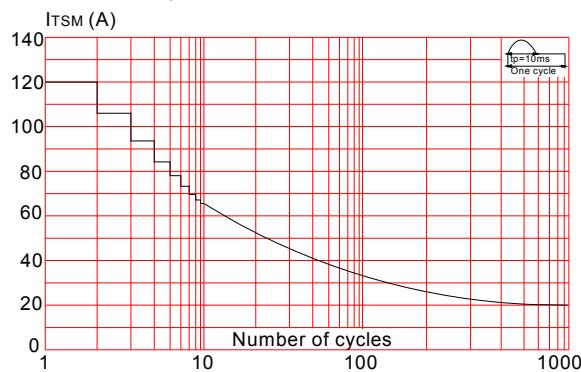


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10\text{ms}$, and corresponding value of $\dot{I}t$ ($dI/dt < 50\text{A}/\mu\text{s}$)

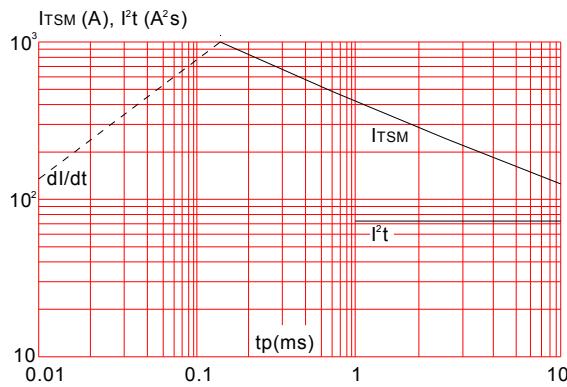


FIG.2: RMS on-state current versus ambient temperature (printed circuit board FR4, copper thickness:35μm)(full cycle)

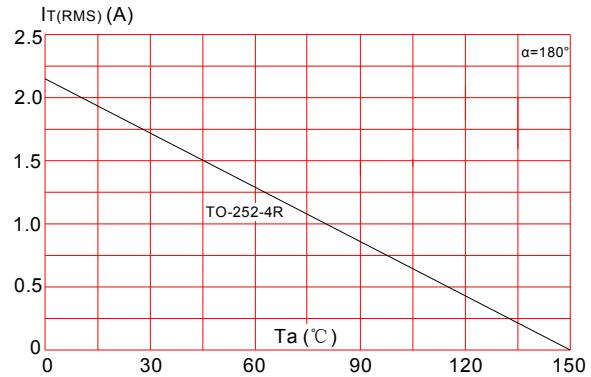


FIG.4: On-state characteristics (maximum values)

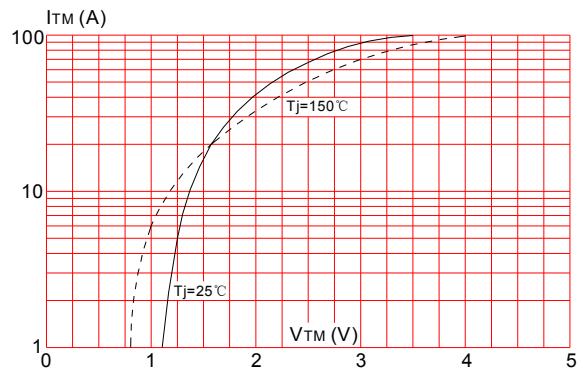
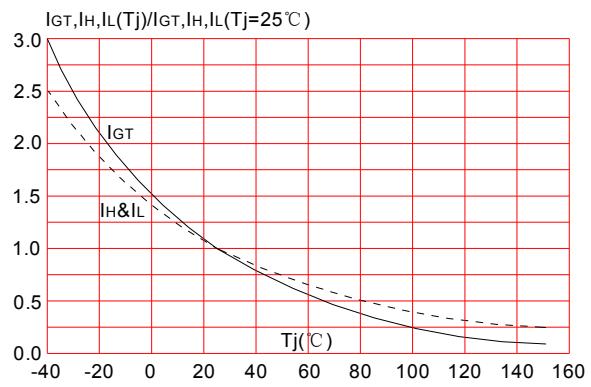
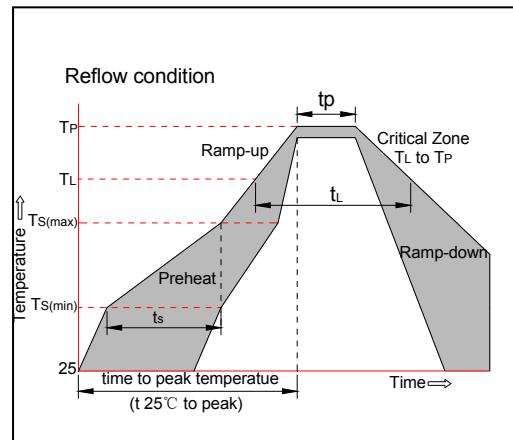


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature



SOLDERING PARAMETERS

| | | |
|--|--------------------------------------|---|
| Reflow Condition | | Pb-Free assembly (see figure at right) |
| Pre Heat | -Temperature Min ($T_{S(min)}$) | +150°C |
| | -Temperature Max($T_{S(max)}$) | +200°C |
| | -Time (Min to Max) (t_s) | 60-180 secs. |
| Average ramp up rate (Liquidus Temp (T_L)to peak) | | 3°C/sec. Max |
| $T_{S(max)}$ to T_L - Ramp-up Rate | | 3°C/sec. Max |
| Reflow | -Temperature(T_L) (Liquidus) | +217°C |
| | -Temperature(t_L) | 60-150 secs. |
| Peak Temp (T_p) | | +260(+0/-5)°C |
| Time within 5°C of actual Peak Temp (t_p) | | 20-40secs. |
| Ramp-down Rate | | 6°C/sec. Max |
| Time 25°C to Peak Temp (T_p) | | 8 min. Max |
| Do not exceed | | +260°C |



Information furnished in this document is believed to be accurate and reliable. However, Jiangsu JieJie Microelectronics Co.,Ltd assumes no responsibility for the consequences of use without consideration for such information nor use beyond it. Information mentioned in this document is subject to change without notice, apart from that when an agreement is signed, Jiangsu JieJie complies with the agreement. Products and information provided in this document have no infringement of patents. Jiangsu JieJie assumes no responsibility for any infringement of other rights of third parties which may result from the use of such products and information. This document is the seventh version which is made in 25-Jan.-2019. This document supersedes and replaces all information previously supplied.

 is a registered trademark of Jiangsu JieJie Microelectronics Co.,Ltd.

Copyright ©2019 Jiangsu JieJie Microelectronics Co.,Ltd. Printed All rights reserved.